



Messe München International

LOPEC 2014 Conference Programm







6th International Exhibition and Conference for the Printed Electronics Industry www.lopec.com Exhibition: 27.–28. Mai 2014 Conference: 26.–28. Mai 2014 Messe München, Germany





Conference Program Overview – Day 2

Exhibition: May 27–28, 2014 Conference: May 26–28, 2014

Messe München, Germany



Customized Building Blocks for Your Participation | Program Overview (for details see www.lopec.com)

Tuesday – May 27, 2014

Conference Program Overview – Day 1

Monday – May 26, 2014

Short Courses	Scientific Confer	rence	Plenary Session - Room 14b				Plenary Session – Room 14b 09:00 am Japan's strategy for the gro			
09:30 am Materials for Organic and Printed Electronics	09:20 am Sensors and Systems	09:20 am Printing Technologies	09:15 am Heraeus 09:40 am EU strat	 09:00 am Words of Welcome 09:15 am Heraeus' Strategy towards Future Growth Markets 09:40 am EU strategy for organic electronics & photonics 10:05 am Flex Nodes for Connected People 					09:25 am Metal M	esh Touch Sensors Photovoltaic in build olutions for Zero Ene
Room 14b	Room 14a	Room 14c		COFFE	E BREAK		-			COFFEE
COFFEE			Technical Confe	rence	Scientific Confe	rence		<	Technical Confe	rence
11:30 am Solution processable organic electronic devices	11:30 am Encapsulation and Processing	11:30 am Inkjet Printing	11:30 am Organic Electronic Systems	11:30 am Advances in Flexible Display Technologies	11:30 am OPV	11:30 am Novel Printing and Processing	Hall B0	Start-up FORUM	11:30 am OLED Lighting	11:30 am Thin Film Encapsulation and Test Methods
Room 14b	Room 14a	Room 14c	Room 13a	Room 13b	Room 14a	Room 14c		Sta	Room 13a	Room 13b
LUN	СН			LU	NCH		NOIL			LUM
02:00 pm Printing, Deposition and Patterning	02:00 pm Thin Film Transistors	02:00 pm Inorganic Materials and Nanomaterials	02:00 pm Technology and Manufacturing Advances in OPV and Battery Technologies	02:00 pm Touch Screens and Surfaces	02:00 pm Integrated Smart Systems and RFID	02:00 pm Device Design	EXHIBI	FORUM	02:00 pm Advances in Substrates and Materials for Printed Electronics	02:00 pm 3D Printing and Digital Fabrication
Room 14b	Room 14a	Room 14c	Room 13a	Room 13b	Room 14a	Room 14c		0B	Room 13a	Room 13b
COFFEE	BREAK			COFFE	E BREAK		-	R F		COFFEE
04:00 pm Hybrid Systems: Stretching the Limits of Electronics	04:00 pm Analysis and Optimization of PE Technologies Room 14a	04:00 pm Processes for OLED Manufacturing	04:00 pm Emerging Technologies for Organic and Large Area Electronics Room 13a	04:00 pm Upscaling Production – Processing Methods and Equipment Room 13b	04:00 pm OLEDs Room 14a	04:00 pm Organic Materials		EXHIBITOR	04:00 pm Sensing in Health and Wellbeing Applications	04:00 pm Advances in Hybrid Integration for Flexible Electronics
			Room 13a	Room 13b	Hoom 14a	H001114C			Room 13a	Room 13b
			06:00 pm TC Poster Sessi	on – ICM Foyer	06:00 pm SC Poster Sessi	on – ICM Foyer				

Conference Program Overview – Day 3

h of printed electronics technology & business

Wednesday – May 28, 2014

	 09:50 am Organic Photovoltaic in building applications. Glass Solutions for Zero Energy Buildings 10:15 am Printed Intelligence Towards Products and Industrialisation 						
	Technical Confer	rence	Business Conference				
	11:30 am OLED Lighting	11:30 am Thin Film Encapsulation and Test Methods	11:30 am Turning Printed Electronics into Business	EXHIBITION – Hall BO			
5	Room 13a	Room 13b	Room 14a		Σ		
		LUNC	н ———	Ó	B		
	02:00 pm	02:00 pm	02:00 pm	B	R T		
	Advances in Substrates and Materials for Printed Electronics	3D Printing and Digital Fabrication	Industry Forecasts and End-User Requirements	EXH	EXHIBITOR FORUN		
	Room 13a	Room 13b	Room 14a				
		COFFEE B	REAK				
	04:00 pm	04:00 pm	04:00 pm				
	Sensing in Health and Wellbeing Applications	Advances in Hybrid Integration for Flexible Electronics	OPV – Quo Vadis?				
	Room 13a	Room 13b	Room 14a				



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Short Courses | Monday, May 26, 2014 | Room 14b

Materials for Organic and Printed Electronics (09:30 am - 11:00 am)

Organic Materials for Organic Electronics Applications

Prof. Ullrich Scherf

Macromolecular Chemistry group and Institute for Polymer Technology, Bergische Universität Wuppertal, Macromolecular Chemistry group and Institute for Polymer Technology, Germany

Solution processable organic electronic devices (11:30 am — 01:00 pm)

Solution processable organic electronic devices Prof. Ronald Österbacka Åbo Akademi, Turku, Professor of Physics, Chair of Center for Functional Materials, Finland

Printing, Deposition and Patterning (02:00 pm - 03:30 pm)

Manufacturing methods and challenges for printing electronics. Mr Tim Claypole Swansea University, UK

Hybrid Systems: Stretching the Limits of Electronics (04:00 pm - 05:30 pm)

Stretching the Limits of Electronics Mr M. Marc Koetse Integration Technologies for Flexible Systems, Holst Centre, Netherlands



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Scientific Conference | Monday, May 26, 2014

Sensors and Systems | Room 14a

- 09:20 am Fully gravure printed carbon nanotube based flexible and disposable wireless cyclic voltammetry tag
 Dr Younsu Jung
 Sunchon National University, Korea, South
- 09:40 am Multi-Parametric Flexible Sensors Based on Nanoparticles Ms Meital Segev-Bar Technion - Israel Institute of Technology, Israel
- 10:00 am Chip-on-Foil Devices for DNA Analysis Based on Inkjet Printed Silver Electrodes Mr Sebastian Wünscher Friedrich Schiller University Jena, Germany

Printing Technologies | Room 14c

- 09:20 am Towards fully roll-to-roll solution processed large area OLED devices Prof. Dr Pim Groen Holst Centre - TNO, Netherlands
- 09:40 am Porous Air bearing techniques for contactless handling, flattening and stabilization of flexible substrates Mr Ivo Hamersma IBS Precision Engineering, Netherlands
- 10:00 am Simulation of Doctoring and Inking Processes for Gravure Printing of Silver Micro Patterns on Thin Film Mr Huu Phuong Hoang Konkuk University, Korea, South
- 10:20 am Development of patterning and printing technologies for large area functional films Dr Xuechuan SHAN SIMTech, Singapore





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Scientific Conference | Monday, May 26, 2014

Encapsulation and Processing | Room 14a

11:30 am High Quality Metallic Grid Preparation on Large Area ITO-Coated Plastic Substrates Dr Larissa Grinis

Bar-Ilan University, Senior Scientist, Israel

- 11:50 am **Time dependent permeation of water vapor through multilayer barrier films used for the encapsulation of organic photovoltaic modules** Mr Oliver Miesbauer Fraunhofer-Institut für Verfahrenstechnik und Verpackung IVV, Germany
- 12:10 pm Capillary Suspensions- A New Formulation Route for Printable Electronics Ms Monica Schneider Karlsruhe Institut of Technology, Germany
- 12:30 pm Insights on the blend morphology and process optimization by optical metrology for roll-to-roll organic photovoltaics applications Dr. A. Laskarakis Aristotle University of Thessaloniki, Greece

Inkjet Printing | Room 14c

- 11:30 amJetting of functional structures on moulded 3D devicesMr Bernhard PolzingerHSG-IMAT, Head of Group Printing Technology, Germany
- 11:50 am UK/Catalan project DigiPRINT on Large Area High Resolution Digital Printing for Organic Thin Film Transistor Fabrication (Year-1 update) Dr Dimitris Karnakis Oxford Lasers Ltd, Technical Manager - R&D Projects, UK
- 12:10 pm Fabrication of transparent electrodes by printing and self assembly of metal precursors and nanoparticles Mr Michael Layani The Hebrew University of Jerusalem, PhD Student, Israel
- 12:30 pm Inkjet printing and intense pulsed light sintering of nanoparticle silver patterns – Influence of flashing parameters and substrate Ms Dana Weise Technische Universitaet Chemnitz, Germany



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Scientific Conference | Monday, May 26, 2014

Thin Film Transistors | Room 14a

- 02:00 pm High performance printed organic transistors using a novel scanned thermal annealing technology Mr Gerd Grau University of California, Berkeley, PhD Student, USA
- 02:20 pm Novel high-performing photopatternable dielectrics for organic Thin-Film-Transistors Dr Herbert Gold Joanneum Research, Scientist, Austria
- 02:40 pm Key control factor for mass-production of fully roll-to-roll (R2R) gravure printed carbon-nanotube-based thin film transistors Mr Hyunmo Koo Sunchon National University, Korea, South

Inorganic Materials and Nanomaterials | Room 14c

02:00 pm SILVER NANOWIRE NETWORKS FOR FOLDABLE TRANSPARENT **ELECTRODES** Dr Xinning Ho Singapore Institute of Manufacturing Technology, Singapore **Copper Precursors for Flexible and Plastic Electronics** 02:20 pm Prof. Shlomo Magdassi The Hebrew University of Jerusalem, Israel 02:40 pm Selective sintering of inkjet-printed metal nanoparticles onto polyethylene terephthalate substrate Dr Daniel ?yme?ka Ecole des Mines de Saint-Etienne, Post-doctoral research fellow, France Transparent metal oxide thin film with high thermal stability, 03:00 pm hardness, and chemical Prof. Dr Hsueh-Shih Chen

National Tsing Hua University, Taiwan



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Scientific Conference | Monday, May 26, 2014

Analysis and Optimization of PE Technologies Room 14a			Processes for OLED Manufacturing Room 14c		
04:00 pm	INKJET GATE ARRAY: Novel concept to implement electronic systems Prof. Dr Jordi Carrabina Universitat Autonoma de Barcelona, Laboratory Director, Spain	04:00 pm	Solution processing of self-assembled monolayers in printing relevant timescales Mr Milan Alt Merck KGaA / Karlsruher Institut für Technologie, PhD student, Germany		
04:20 pm	Semi-automatic PE Technology & Device Library Characterization for PDK Development Mr Francesc Vila IMB-CNM (CSIC), Engineer, Spain	04:20 pm	OLED on flexible Glass from Sheet-to-Sheet to Roll-to-Roll Fabrication Dr Stefan Mogck Fraunhofer COMEDD, Germany		
04:40 pm	Analysis of Geometric Modeling of Slot Die Lips Mr NAOKI RIKITA MMC RYOTEC CORPORATION, Technical Director, Japan	04:40 pm	Inkjet-printed diodes based on metal-insulator-semiconductor (MIS) structure for rectifying application in flexible electronics Mr Kalyan Yoti Mitra Technische Universitaet Chemnitz, Germany		
		05:00 pm	Large-area, flexible, ITO-free Organic Light Emitting Diodes fabricated on fabric-based electrodes Dr Oscar Fernandez CSEM, Switzerland		



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Plenary Session | Tuesday, May 27, 2014 | Room 14b

Words of Welcome

- 09:00 am Welcome to LOPEC 2014 Mr Wolfgang Mildner General Chair LOPEC, PolyIC GmbH & Co KG, Managing Director, OE-A Vice-Chairman Europe
- 09:15 am Heraeus' Strategy towards Future Growth Markets Mr Rolf Najork Heraeus Holding GmbH, COO, Germany
- 09:40 am **EU strategy for organic electronics & photonics** Mr Khalil Rouhana European Commission, Director-General for Communications Networks, Content & Technology, Belgium
- 10:05 am Flex Nodes for Connected People Mr Jaap Lombaers Holst Centre, Managing Director, Netherlands



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Technical Conference | Tuesday, May 27, 2014

Advances in Flexible Display Technologies | Room 13b **Organic Electronic Systems | Room 13a Recent Progress in the Development of Integrated Stand-alone** 11:30 am 11:30 am Advanced Detaching Technique for Plastic AMOLED **Electronic Systems** Prof. Jin Jang Mr Henrik Sjoeberg Kyung Hee University, Korea, South Thin Film Electronics AB, Sr Vice President, Product Management, Active Matrix OLED backplanes made of organic thin-film Sweden 11:50 am transistors Complementary organic transistors printed on foil: from process Dr. Hans Kleemann 11:50 am technology to circuits and systems Novaled, Germany Dr. Eugenio Cantatore Low temperature organic transistor process for flexible displays TU Eindhoven, Associate Professor, Netherlands 12:10 pm with 1mm bend radius 12:10 pm Electrical and printing integration for printed electronic on paper: Dr Simon Ogier Centre for Process Innovation, R&D Manager, UK Dr Delattre Anastasia CTP, Chemist ingerieur, France Applications of Printed Electronics on Paper-based Substrates: 12:30 pm Creating sustainable and functional packaging Dr Gary Li FPInnovations, Scientist, Canada



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Technical Conference | Tuesday, May 27, 2014

Technolog Room 13a	gy and Manufacturing Advances in OPV and Battery Technologies	Touch Scr	reens and Surfaces Room 13b
02:00 pm	Towards roll-to-roll mass production of efficient organic	02:00 pm	Silver Nanowires: Enabling the Future of Touch Dr. Tryg Jensen
	vacuum-deposited p-i-n tandem solar cells Dr Christian Uhrich		Carestream Advanced Materials, R&D Manager, USA
	Heliatek, Head of R&D Physics, Germany	02:20 pm	High-Conductive PEDOT:PSS in Touch Sensors Dr. Andreas Elschner
02:20 pm	High efficiency polymer semiconductors for organic photovoltaics with improved stability		Electronic Materials Division, Head Technical Service BU FC, Germany
	Dr Owen Lozman Merck Chemicals, R&D Manager, UK	02:40 pm	PolyTC® - Metal mesh based Touch sensors Mr Johannes Schad PolyIC GmbH & Co. KG, Product Manager, Germany
02:40 pm	Custom made OPV by ink jet printing Dr Charles Roger DisaSolar, Materials & Processes Engineer, France		
03:00 pm	Thin Batteries and their Applications Mr John Gannon Blue Spark Technologies, Inc., President and CEO, USA		



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Technical Conference | Tuesday, May 27, 2014

Emerging	Technologies for Organic and Large Area Electronics Room 13a	Upscaling	Production - Processing Methods and Equipment Room 13b
04:00 pm	Flexible thin film plastic photovoltaics for energy harvesting and off-grid solar Dr. Michael Niggemann Eight19 Ltd, CTO, UK	04:00 pm	Patterning and Thin Film layer application methods for Printed Electronics Mr Thomas Kolbusch Coatema, Vice President, Germany
04:20 pm	MC10's Biostamp platform: Delivering seamless, body-integrated computing that dissolves the boundaries between technology and humans. Mr Brian Elolampi MC10, USA	04:20 pm	Printing versus coating technology – Which way Printed Electronics will go? Ms Andrea Glawe KROENERT GmbH & Co KG, Director R&D, Germany
	,	04:40 pm	Inkjet production equipment; scale-up from lab to fab
04:40 pm	New manufacturing process step for LEC, enabling additive layer		Mr Joost Valeton
	application without need for orthogonal solvent systems. Dr Andreas Sandström		Roth&Rau B.V., Netherlands
	LunaLEC AB, CTO, Sweden	05:00 pm	Changing the Future in R2R Manufacturing of Flexible Electronics Dr Sorin Stan
05:00 pm	Potential free plasma technology for treatment of electrical high sensitive films Mr Frank Hochstrate SOFTAL Corona & Plasma GmbH, Area Manager, Germany		VDL FLOW, Netherlands





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Scientific Conference | Tuesday, May 27, 2014

OPV | Room 14a **Novel Printing and Processing | Room 14c** 11:30 am Analysis of Dynamic Electrical Response of Fresh and Degraded 11:30 am **Customised Solutions for Rapid Photonic Processing Organic Solar Cells** Prof. Dr Uwe Krönert Mr Martin Neukom Heraeus Noblelight Ltd., Cambridge, UK, Scientific consultant, Fluxim AG, Switzerland Germany Matching the subcell currents in organic tandem solar cells via 11:50 am 11:50 am Wireless Bio Sensing Platform using Printed Electrodes and spatial photocurrent mapping **Flexible Battery** Mr Konstantin Glaser Dr Fredrik Jonsson Karlsruhe Institute of Technology (KIT), Germany KTH, Royal institute of Technology, Sweden 12:10 pm Plasmonic organic photovoltaics based on shape controllable 12:10 pm Integrated applications driven by printed primary battery silver nanoplates. solutions Mr Hsu Hsiang-Lin Dr Andreas Willert Ming Chi University of Technology, Taiwan Fraunhofer ENAS, Senior Scientist, Germany Assessing batch-to-batch variation of photovoltaic polymers by Towards an all plasma-printed biosensor 12:30 pm 12:30 pm spectroscopy and optical simulation Mr Peter Verhoeven Dr Markus Kohlstädt InnoPhysics B.V., Netherlands Fraunhofer Institute for Solar Energy Systems ISE / Universität Freiburg, Germany



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Scientific Conference | Tuesday, May 27, 2014

Integrated Smart Systems and RFID | Room 14a

- 02:00 pm Fully Inkjet Printed, Multilayer Lithium-ion Battery Mr James Cooper Georgia Institute of Technology, Graduate Research Assistant, USA
- 02:20 pm Integration of printed electronic components for devices Dr. Mark Allen Nokia Research Centre, Senior Researcher, UK
- 02:40 pm **Printed Smart RFID Labels for the Monitoring of Perishable Goods** Dr Danick Briand Ecole Polytechnique Fédérale de Lausanne (EPFL), Switzerland
- 03:00 pm Vertically-Integrated Inkjet Printed Electronics Process (VIPRE) for High Efficiency RF and mm-Wave Components Mr Benjamin Cook Georgia Institute of Technology, USA

Device Design | Room 14c

- 02:00 pm Light Management for Organic Photovoltaics Dr Ton Offermans CSEM, Switzerland
- 02:20 pm Integration of OLED lighting in automotive plastic components Dr Bert Geyer ZOEK GmbH, Germany
- 02:40 pm Printed Fringing Field Capacitive Sensors: A Multidisciplinary Approach Mr João Gomes CeNTI - Centre for Nanotechnology and Smart Materials, R&D manager of the Smart Materials and Systems, Portugal
 03:00 pm Smart Skin for Robotics – an Example of a Complex System-In-Foil

Dr Harald Richter Institut für Mikroelektronik Stuttgart, Germany





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Scientific Conference | Tuesday, May 27, 2014

OLEDs | Room 14a 04:00 pm Design tool for light scatterin

- 04:00 pm **Design tool for light scattering enhancement in OLEDs** Mr Thomas Lanz Fluxim AG, Technical consultant, Switzerland
- 04:20 pm High-Performance Stacked Inverted Top-Emitting Green and White Electrophosphorescent Organic Light-Emitting Diodes Mr Keith Knauer Georgia Institute of Technology, Graduate Research Assistant, USA
- 04:40 pm Characteristics of all-solution printed transparent OLED signage and lighting panels Mr Markus Tuomikoski VTT, Finland

Organic Materials | Room 14c

04:00 pm New Materials for OLED and OPV Dr Arnulf Scheel Heraeus Precious Metals GmbH&Co.KG, Germany Printed and encapsulated environmental sensors on 04:20 pm biodegradable polylactic acid (PLA) Mr Andrés Vásquez Quintero Ecole Polytechnique Fédérale de Lausanne (EPFL), Research Assistant, Switzerland Studying the influence of temperature treatment on 04:40 pm Poly(3,4-ethylenedioxythiophene) polystyrenesulfonate (PEDOT:PSS) thin films Mr Antonio Margues CeNTI - Centre for Nanotechnology and Smart Materials, Researcher, Portugal



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Start-up Forum | Tuesday, May 27, 2014 | LOPEC Forum

launch event

11:00 am the key parameters to make a start-up successful Mr Gildas Sorin Novaled GmbH, CEO, Germany

B-Round

- 11:20 am Organic and printed electronics: innovative smart products Mr Pascal Pierron Dracula Technologies, Business Developer, France
- 11:30 am **PST Sensors making sense with silicon** Mr David Britton PST Sensors, South Africa
- 11:40 am Additive Manufacturing of 3D Printed Thin Film Electronics and Circuits Using Precision Shadow Masks and Alignment Bridging the Gap between Integrated Circuits and Printed Circuit Boards Mr Whitten (Whit) Little Advantech US, Inc., President and CEO, USA
- 11:50 am Singlet Harvesting Emitters for highly efficient OLEDs Dr Tobias Grab Cynora GmbH, CEO, Germany
- 12:00 pm Slot die coating a key technology for scalable manufacturing of Organic & Printed Electronics Mr Miguel Friedrich nTact, Vice President Sales & Marketing, USA
- 12:10 pm Annealing Free Metal Nanoink Prof. Dr Masayuki Kanehara Colloidal Inc. Co., Ltd., CEO, Japan



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Start-up Forum | Tuesday, May 27, 2014 | LOPEC Forum

B-Round

12:30 pm Printed Electrochromic Film for Architectural and Automotive Applications Dr Damoder Reddy Argil, Inc., Founder & CEO, USA

12:50 pm Fabrigen – Lightweight Flexible PV Dr Robert Carpenter FlexiSolar Ltd, MD, UK

Seed Financing

12:20 pm **How to outperform ITO** Ms Valérie ZOPPI Genes'ink, Project leader - Senoir material engineer , France

12:40 pm **Foils for vehicles** Mr Antti Backman Delektre Ltd., CEO, Finland



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Technical Conference Poster Session | Tuesday, May 27, 2014 | ICM Foyer

Technology and Manufacturing Advances in OPV and Battery Technologies (06:00 pm — 08:00 pm)

1.1 **OPV - A STEP TO COMPETITIVENESS & NEW OPPORTUNITIES** Mr BARREAU FRANCOIS ARMOR SAS , Marketing Manager, France

OLED Lighting (06:00 pm - 08:00 pm)

- 2.1 Scaling up the Optoelectronics Platforms technology and challenges Mr Mike Clausen Centre for Process Innovation (CPI), Optoelectronics Platform Manager, UK
- 2.2 Simultaneous Multilayer Coating for mass-producible flexible light Mr Moritz Graf zu Eulenburg InovisCoat GmbH, Managing Director, Germany

2.3 Study, design and development of encapsulation process for organic devices supported by an semi-automatic equipment Mr Andre Pinto CeNTI - Centre for Nanotechnology and Smart Materials, Researcher,

Portugal

Advances in Substrates and Materials for Printed Electronics (06:00 pm - 08:00 pm)

- 4.1 Advanced parameter control for inkjet material development Dr Jack Beurskens Roth&Rau B.V., Netherlands
- 4.2 **Solvay formulations for Organic Field Effect Transistors devices.** Dr Mathieu Fenoll Solvay, R&D Specialist, Belgium

- 4.3 Photonically and Thermal Sintered Silver Conductors for Printed Electronics Applications Dr Dave Hui DuPont (UK) Limited, Product Development Scientist, UK
- 4.4 **The importance of Suspensions in the value-added chain for organic electronic applications** Mr Ulf Koepke EXAKT Advanced Technologies GmbH, R&D Manager, Germany
- 4.5 Copper Nanoparticle Ink for Reverse Offset Printing and its Application to Thin Film Transistors (TFTs) Mr Masayoshi Koutake JAPERA, Japan
- 4.6 Nanoparticulate n- and p-type metal oxide interfaces for different architectures in polymer solar cells Dr Norman Lüchinger Nanograde AG, Switzerland
- 4.7 **Tungsten Carbide Lip Slot Die** Mr NAOKI RIKITA MMC RYOTEC CORPORATION, Technical Director, Japan
- 4.8 Next-Generation Printable Conductive Nanotube Materials and Sensors Mr Ramachandran Trichur Brewer Science Inc, Business Development Manager, USA
- 4.9 Advances in Thin, Printable Conductors Mr Peter Willaert Agfa-Gevaert N.V., Product Manager Printed Electronics, Belgium



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Technical Conference Poster Session | Tuesday, May 27, 2014 | ICM Foyer

Advances in Substrates and Materials for Printed Electronics (06:00 pm - 08:00 pm)

4.10 Flexible electronics materials using roll-to-roll atomic layer deposited coatings Dr Kimmo Lahtinen

Lappeenranta University of Technology, Finland

Advances in Flexible Display Technologies (06:00 pm - 08:00 pm)

- 6.1 **P-Ink Displays: Flexible, Low Power, Reflective Color** Dr Andre Arsenault Opalux Inc., CTO, Canada
- 6.2 Challenges of Thin Film Processing on flexible GLASS SUBSTRATES. Mr Uwe Beier Adenso GmbH, Germany
- 6.3 Flexible organic Light Emitting Diodes with patterned top electrode using gravure offset printer Dr Hyun-Woo Dang Jeju National University, Doctor, Korea, South

Upscaling Production - Processing Methods and Equipment (06:00 pm - 08:00 pm)

- 7.1 Large volume continuous synthesis of metal oxide nanoparticle inks toward inkjet printed TFT devices Dr Sean Butterworth Promethean Particles, UK
- 7.2 Formalization of Design Rules and generation of related structures using pCells
 Mr Mohammad Mashayekhi
 Universitat Autonoma de Barcelona, Laboratory Director, Spain

- 7.3 Electroluminescent devices scale-up by screen printing R2R processes Mrs. Cristina Casellas CETEMMSA, Product Manager, Spain
- 7.5 Bridging the gap between R2R R&D and Pilot Production Mr Miguel Friedrich nTact, Vice President Sales & Marketing, USA
- 7.6 Towards the industrial scale production of printed electronic devices by roll-to-roll inkjet printing combined with photonic sintering Prof. Dr Pim Groen Holst Centre - TNO, Netherlands
- 7.7 In-line Monitoring & Quality Control of R2R Processes for Production Optimization of Printed Electronics Dr Christos Koidis Organic Electronic Technologies P.C., General Manager, Greece
- 7.8 **Development of new products with optimized slot dies** Mr Maick Nielsen TSE Troller, CEO, Switzerland
- 7.9 Airship with printed surfaces Mr Tommi Rintala Delektre Ltd., VP Technology, Finland
- 7.10 **Non-contact motion in vacuum for OLED deposition processes** Mr Jan van Gerwen Bosch Rexroth B.V., Business Development Manager, Netherlands
- 7.11 Drying and sintering of printed functionalities: comparison of Infrared and Xenon flash technology
 Mr Juergen Weber
 Heraeus Noblelight GmbH, project manager, Germany



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Upscaling Production - Processing Methods and Equipment (06:00 pm - 08:00 pm)

7.12 Continuous Flow Synthesis of Regioregular Poly(3-Hexylthiophene): Ultrafast Polymerization with High Throughput and Low Polydispersity Index Prof. Anil Kumar

Indian Institute of Technology Bombay, Professor, India

Thin Film Encapsulation and Test Methods (06:00 pm - 08:00 pm)

- 8.1 **Development and characterization of Ultra high barrier for organic** electronics using atomic layer deposition and Ca mirror test. Mr Claus Luber Fraunhofer COMEDD, Germany
- 8.2 **High Barrier Material Test Methods** Mr Andreas Roos Paul Lippke Handels GmbH, Product Manager, Germany

Sensing in Health and Wellbeing Applications (06:00 pm - 08:00 pm)

10.1 **Ink-jet printed electrochemical immunosensors** Mr Alexey Yakushenko Forschungszentrum Jülich, Germany

Emerging Technologies for Organic and Large Area Electronics (06:00 pm – 08:00 pm)

 12.1 High Quality Metallic Grid Preparation on Large Area ITO-Coated Plastic Substrates
 Dr Larissa Grinis
 Bar-Ilan University, Senior Scientist, Israel 12.2 Printing Electronic Systems using a Novel Bulk Material Patterning Technique Mr Scott Lauer Advantech US, VP Product Development, USA



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Scientific Conference Poster Session | Tuesday, May 27, 2014 | ICM Foyer

Materials (06:00 pm - 08:00 pm)

1.1 Deposition of transparent conducting AZO thin films on flexible ITO/PET substrate Ms Nihan Ak?n

Gazi University, Turkey

- 1.2 Synthesis of silicon nanowire arrays for photovoltaic applications Mr Amir Bani Hashemi University of Ulm, Germany
- 1.3 Photophysical studies of the thermally-activated delayed fluorescence of a mononuclear copper(I) compound Ms Larissa Bergmann cynora GmbH, Germany
- 1.4 Surface morphology and PCBM aggregation control in P3HT: PCBM thin film by applying various electrostatic fields on BHJ polymer solar cells, critical performance and photovoltaic characterization comparison Ms Fatemeh Davoudi Islamic Azad University, science and research branch, Iran
- 1.5 **High Silver Content Nanoparticle-Based Conductive Inkjet Ink** Dr. Hsin Chem Chang Industrial Technology Research Institute, Taiwan
- 1.6 Highly concentrated and conductive reduced graphene oxide nanosheets by monovalent cation pi interaction:Toward printed electronics

Dr Seung-Yol Jeong

Korea Electrotechnology Research Institute, Senior Researcher, Korea, South

1.7 Laser induced one step method for synthesis and patterning of onion like carbon.

Dr Kyungtae Kang Korea Institute of Industrial Technology, Korea, South

- 1.8 **Partial carbon footprint estimate for printed electronic circuit** Mr Simo Siitonen Stora Enso Oyj, Research Cenre Imatra, Research Engineer, Finland
- Ultra-barrier encapsulation by ALD R2R processing for flexible large area devices.
 Dr ALFRED SMITH
 Centre for Process Innovation Ltd. (CPI), Business Development Manager, UK
- 1.10 Solution Processing of Hierarchical Poylymeric Nanoarrays for Thermal Management and Energy Applications Mr Matthew Smith Georgia Institute of Technology, USA

Devices (06:00 pm — 08:00 pm)

- 2.1 Parameter Simulation of Transmission System by Electromagnetic Oscillations of Radio-Frequency Bandwidth in the ELECTRONICS WORKDENCH Software Environment Prof. Dr Erkin Artykov Moscow State University of Printing Arts, Head, section of Electrical Engineering and Electronics, sub-faculty of Natural Sciences, Russia
- 2.2 Roll to Roll printing of large area Organic Photovoltaic Modules Dr Gianni Corso eni spa, Italy



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Scientific Conference Poster Session | Tuesday, May 27, 2014 | ICM Foyer

Devices (06:00 pm — 08:00 pm)

- 2.3 Modification of high resolution PEDOT:PSS electrodes for performance enhancement of fully printed transistor devices and circuitries Mr Daniel Höft Technische Universität Chemnitz, Germany
- 2.4 Illumination effects on Organic Thin-Film Transistor Prof. Chin-Tsou Kuo Tatung University, Prof., Taiwan
- 2.5 **Inkjet-based OFET biosensor on flexible substrate platform** Ms Carme Martínez-Domingo Universitat Autònoma de Barcelona, Researcher, Spain
- 2.6 Use of Identification Marks in Automated Control Systems (ACS) of a Printing Enterprise Dr Olga Mikhaylova Moscow State University of Printing Arts, Associate Professor, Russia
- 2.7 Screen printed resistors based on PEDOT:PSS Mr Silvan Pretl University of West Bohemia, PhD student, Czech Republic
- 2.8 **Manufacturing of thin-film transistors using industrial inkjet printheads** Mr Enrico Sowade TU Chemnitz, Germany
- 2.9 Smart RFID label printed on PET substrate with CMOS sensors Mr Andrés Vásquez Quintero Ecole Polytechnique Fédérale de Lausanne (EPFL), Research Assistant, Switzerland

2.10 Comparative degradation study of P3HT solar cells using different hole transporting materials Mr Simon Zuefle Fluxim AG, Switzerland

Printing, Patterning Technologies and Appropriate Equipment (06:00 pm – 08:00 pm)

- 3.1 Femtosecond laser structuring of metal electrodes for organic solar cells Mr Joshua Alejandro Fragoso Garcia Karlsruhe Institute of Technology, Research coworker, Germany
- 3.2 **Optimization of SU-8 via Fabrication using ink jet printing** Mr Adam Giang MicroChem, Applications Engineer, USA
- 3.3 The Influence of the Doctoring Process Parameters on the Performance of Organic Thin Film Transistor in R2R Gravure Printing Process Mr Ji-Youp Kim Konkuk university, Korea, South
- 3.4 The preparation and characterization of CuO inkjet inks for material printing Mr Petr Kr?má? Tomas Bata University in Zlín, Czech Republic
- 3.5 Development of inkjet-printed flexible temperature sensors used in inserted soles Ms Laura Liedtke HSG-IMAT, Research assistant, Germany
- 3.6 **The preparation and characterization of ITO ink for gas senzing** Mr Jan Maslik Tomas Bata University in Zlin, Czech Republic



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Scientific Conference Poster Session | Tuesday, May 27, 2014 | ICM Foyer

Printing, Patterning Technologies and Appropriate Equipment (06:00 pm – 08:00 pm)

- 3.7 Characterization of printed NFC tags on paper using different printing and sintering processes Mr Victor THENOT Arjowiggins, Research Engineer - PhD Student, France
- 3.8 A Study on Performance Evaluation of Metal Grid Mesh Transparent Conductive Films for Organic Light Emitting Diodes Prof. Dr Dong Soo Kim Hanbat National University, School of Global Convergence Studies, Professor, Korea, South

Products (06:00 pm — 08:00 pm)

- 4.1 High luminescence flexible surface by LEDs bonded into flexible foil with plastic overmoulding
 Mr Arttu Huttunen
 VTT Technical Reseach Centre of Finland, Research scientist, Finland
- 4.2 Fabrication and characterization of transparent conducting film using single-walled carbon nanotubes/Ag nanowires via R2R processes Prof. Dr Haeseong Lee Jeonju University, Professor, Korea, South

Device and Circuitry Design, Simulations (06:00 pm - 08:00 pm)

5.1 **Design and simulation of frequency selective screen at 2,4 GHz** Mr Matija Mraovic Pulp and paper institute, Young researcher, Slovenia

- 5.2 An inkjet adaptive backend strategy for low-yield OTFT digital circuits Dr Eloi Ramon Universitat Autonoma de Barcelona, Researcher, Spain
- 5.3 **Sub-micrometer organic thin-film transistors: technology assessment** Mr Frédéric Zanella CSEM SA / EPFL, Ph.D. Student, Switzerland

Quality Control in Production Lines (06:00 pm — 08:00 pm)

- 6.1 Consideration of water vapor adsorption effects for the reliable testing of the water vapor transmission rate of ultra-barrier samples Dr Wulf Grählert Fraunhofer IWS, Germany
- 6.2 **Tension control of winder web in roll-to-roll printing system using fuzzy PID control method** Prof. Dr Chung Hwan Kim

Chungnam National University, Korea, South



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Plenary Session | Wednesday, May 28, 2014 | Room 14b

Words of Welcome

- 09:00 am Japan's strategy for the growth of printed electronics technology and business Mr Hitoshi Abe Dai Nippon Printing Co., Ltd., President of JAPERA, Japan
- 09:25 am Metal Mesh Touch Sensors Mr Bob Mackey Synaptics, Principal Scientist, USA
- 09:50 am Organic Photovoltaic in building applications. Glass Solutions for Zero Energy Buildings Mr Frédéric Bonnefoy AGC Glass Europe, Product Manager Active Glass, Belgium
- 10:15 am Printed Intelligence Towards Products and Industrialisation Prof. Dr. Harri Kopola VTT Technical Research, Vice President, Microtechnologies and Electronics, Finland



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Technical Conference | Wednesday, May 28, 2014

OLED Lighting | Room 13a

- 11:30 am **OLEDs for functional lighting applications** Mr Eric Meulenkamp Philips Technologie GmbH, R&D manager, Netherlands
- 11:50 am Flexible OLEDs for Lighting Applications Dr Joanne Wilson Holst Centre/TNO, Program Manager, Netherlands
- 12:10 pm Silver Nanowires: The Ultimate Transparent Electrode for OLED and OPV Dr Rahul Gupta Cambrios Technologies, Senior director of business development, USA

Thin Film Encapsulation and Test Methods | Room 13b

11:30 am Ultra-high permeation barriers and functional films for large-area flexible electronics
 Dr John Fahlteich
 Fraunhofer - FEP, Senior Scientist-Project Manager, Germany

 11:50 am Environmental barriers for flexible displays
 Dr Lorenza Moro
 Samsung Cheil, Principal Scientist-Project Manager, USA

 12:10 pm Comparing water permeation metrologies
 Dr Giovanni Nisato
 CSEM, Business and technology development senior manager, Switzerland



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Technical Conference | Wednesday, May 28, 2014

Advances	in Substrates and Materials for Printed Electronics Room 13a	3D Printin	g and Digital Fabrication Room 13b
02:00 pm	Materials for Printed Electronics: Boosting System Performance and Processability Dr Jochen Brill BASF, Senior Manager, Germany	02:00 pm	Leading the Next Industrial Revolution Dr. Jan Sumerel MakerBot Industries, LLC, Vice President of Research and Development, USA
02:20 pm	Materials for Organic Electronic Applications Dr Jeremy Burroughes Cambridge Display Technology, CTO, UK	02:20 pm	3D-printing with light: Materials and applications Prof. Dr. Juergen Stampfl Vienna University of Technology, Professor / Inst. of Materials Science and Technology, Austria
02:40 pm	Next-Generation Printable Conductive Nanotube Materials and Sensors Mr Ramachandran Trichur Brewer Science Inc, Business Development Manager, USA	02:40 pm	Integration of Functional Circuits into 3D Printed Parts Ms Alissa Wild Stratasys, Inc., Senior Materials Engineer, USA
03:00 pm	New Developments for Films for Touch Screens and Printed Electronics Dr Bill MacDonald DuPont Teijin Films, Business Research Associate, LIK		

DuPont Teijin Films, Business Research Associate, UK



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Technical Conference | Wednesday, May 28, 2014

Sensing in Health and Wellbeing Applications | Room 13a

- 04:00 pm **Opportunities for Printed Electronics for the Diagnostics Industry** Dr. Sophie Laurenson Abbott, Project Manager, Germany
- 04:20 pm Manufacturing automation: dispensing of reagents on biosensors and rapid diagnostic tests Mr Markku Känsäkoski VTT Technical Research Center of Finland , Finland
- 04:40 pm Printed sensors for the healthcare sector Dr Laura Lopez CETEMMSA, Head of Scientific Valorisation, Spain



02:40 pm

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Business Conference | Wednesday, May 28, 2014 | Room 14a

Turning Printed Electronics into Business

- 11:30 am A smarter everyday powered by Printed Electronics Bringing intelligence to everything Dr. Davor Sutija Thinfilm, CEO, Norway
- 11:50 am Partnering the key enabler to develop the printed electronics industry Mr Bjorn Hofman Merck KGaA, Senior Vice President, Performance Materials ? Advanced Technologies , Germany
- 12:10 pm Printed Electronics moving from R&D to products to answer market mega-trends : internet-of-things, user interfaces for consumer electronics, new health care equipments Mr Laurent Jamet ISORG, Co-founder, Director Business Development, France
- 12:30 pm **Open Innovation Partnerships to move Technology to Market** Mr Ross Bringans PARC, Vice President, Electronic Materials and Devices Laboratory, USA

Industry forecasts and end-user Requirements

- 02:00 pm **THE ELUSIVE BUSINESS OF PRINTED ELECTRONICS** Mr Dale Pritchett Rodman Media, Group Publisher, USA
- 02:20 pm **Towards a Better Forecast for Printed Electronics** Mr David Barnes BizWitz LLC, USA

	Industry Mr Martin Glatz KARL KNAUER KG, Leiter Verkauf & Marketing, Germany
03:00 pm	Solution processed display printing meets the 'year of wearables Mr Dan Rogers Smithers, Head of Digital Publishing, UK

Smart Packaging: Opening New Horizons for the Packaging

OPV - Quo vadis?

- 04:00 pm Organic Phototvoltaics Market driven Business Approaches Dr. Ralph Paetzold Belectric, CEO, Germany
- 04:20 pm Organic Solar Films for active integrated BiPV materials Mr Aron Guttowski Heliatek GmbH, Manager Business Development, Germany